General Specifications

GS 04L21B01-02EN

Model FX1002/FX1004/FX1006/ FX1008/FX1010/FX1012 FX1000 Paperless Recorder



OVERVIEW

The FX1000 (Model FX1002/FX1004/FX1006/ FX1008/FX1010/FX1012) is a Paperless Recorder that displays real-time measured data on a color LCD and saves data on a CompactFlash memory card (CF card)*1 or SD card*2. It can be hooked up to network via Ethernet, which enables to inform by Email and to monitor on Web site as well as to transfer files by using FTP. Also, it can communicate with Modbus/ RTU or Modbus/TCP. It comes with a two, four, six, eight, ten-channel or twelve-channel model. As the input signal, a DC voltage, thermocouple, resistance temperature detector, or contact signal can be set to each channel. The data saved on a CF card/SD card or the data transferred via networks can be converted to Lotus 1-2-3, Excel, or ASCII format file, facilitating processing on a PC. Not only this, the Viewer software allows a PC to display waveforms on its screen and to print out waveforms.

- *1: On FXs that have a CF card slot (suffix code -4.)
- *2: On FXs that have a SD card slot (suffix code -7.)

Signal Input and Alarms

1. Measurement Input

Number of inputs, scan interval, and A/D integration time:

Model	No. of Measurement Channels	Scan Interval	A/D converter integration time
FX1002	2	125 ms,	AUTO ^{*1} , 50 Hz,
FX1004	4	250 ms	60 Hz
FX1006	6	1 s, 2 s, 5 s	AUTO ^{*1} , 50 Hz, 60
FX1008	8		Hz, 100 ms*2
FX1010	10		
FX1012	12		

- *1: AUTO: The FX automatically switches between 50 Hz and 60 Hz depending on the power supply frequency.
- *2: You can only set the integration time to 100 ms on models FX1006 through FX1012. If you set the integration time to 100 ms, you can only set the scan interval to 2 or 5 seconds.
- *1: R, S, B, K, E, J, T, N: IEC 60584-1, DIN EN 60584-1, JIS C1602
- *2: W: W-5%Re/W-26%Re (Hoskins Mfg. Co.), ASTM E988-96
- (Type C equivalent of OMEGA Engineering Inc.)
- *3: L: Fe–CuNi, DIN 43710, U: Cu–CuNi, DIN 43710
 *4: WRe: W-3%Re/W-25%Re (Hoskins Mfg. Co.), ASTM E988-96
- (Type D equivalent of OMEGA Engineering Inc.)
 *5: Pt100: JIS C 1604, IEC 60751, DIN EN 60751 JPt100: JIS C 1604, JIS C 1606. Measuring
- JPt100: JIS C 1604, JIS C 1606. Measuring current i = 1 mA (Pt100, JPt100).
 *6: The range for linear scaling of 1-5V inputs. Burnout
- detection and low-cut functions are available. *7: The detected current value is approximately 10 uA
- *7: The detected current value is approximately 10 μA.





Input Type: DC voltage, 1-5V, thermocouple (TC), resistance temperature detector (RTD), ON/OFF input (DI), and DC current (by adding an external shut resistor) Measurement range and measurable range:

Input Type	Range	Measurable Range				
DC	20 mV	-20.000 to 20.000 r	mV			
voltage	60 mV	-60.00 to 60.00 mV	/			
	200 mV	-200.00 to 200.00 r	mV			
	1 V	-1.0000 to 1.0000 V				
	2 V	-2.0000 to 2.0000	V			
	6 V	-6.000 to 6.000 V				
	20 V	-20.000 to 20.000	V			
	50 V	-50.00 to 50.00 V				
1-5V	1 to 5 V*6	0.800 to 5.200 V				
тс	R ^{∗1}	0.0 to 1760.0°C	32 to 3200°F			
	S*1	0.0 to 1760.0°C	32 to 3200°F			
	B*1	0.0 to 1820.0°C	0.0 to 3308°F			
	K ^{∗1}	–200.0 to 1370.0°C	–328 to 2498°F			
	E*1	–200.0 to 800.0°C	-328.0 to 1472.0°F			
	J*1	–200.0 to 1100.0°C	-328.0 to 2012.0°F			
	T *1	–200.0 to 400.0°C	-328.0 to 752.0°F			
	N*1	–270.0 to 1300.0°C	–454 to 2372°F			
	W*2	0.0 to 2315.0°C	32 to 4199°F			
	L*3	–200.0 to 900.0°C	-328.0 to 1652.0°F			
	U*3	–200.0 to 400.0°C	-328.0 to 752.0°F			
	WRe ^{*4}	0.0 to 2400.0°C	32 to 4352°F			
RTD	Pt (Pt100)*⁵	–200.0 to 600.0°C	-328.0 to 1112.0°F			
	JPt (JPt100) ^{*5}	–200.0 to 550.0°C	-328.0 to 1022.0°F			
DI	Level	0: Less than 2.4 V. 1: 2.4 V or higher (judged at the 6 V range)				
	Contact*7	0: Open. 1: Closed (parallel capacitance of 0.01 µF or less)				

Thermocouple burnout: Burnout upscale/downscale selectable (for each channel). Normal: 2 kΩ or less., Burnout: 100 kΩ or more (parallel capacitance of 0.01 µF or less) Detection current: Approx. 10 µA 1-5 range burnout: Burnout upscale/downscale selectable (for each channel). Burnout detection: Greater than "scale upper limit + 10% of scale width" (upscale), or less than "scale lower limit - 5% of scale width" (downscale) TC reference junction compensation: Internal reference junction compensation or external reference junction compensation Filter function: Takes the moving average of the input values (for each channel). Moving average data points: 2 to 400 Computation: Difference computation: Computable range: DC voltage, TC, RTD, and DI Linear scaling: Computable range: DC voltage, TC, RTD, and DI Scalable range: -30000 to 30000. The decimal place is within 4 digits to the right of the decimal point. Unit: 6 characters or less Over value detection: The value can be set to over value when ±5% of the scale range is exceeded. Square root computation: Takes the square root of the input and apply linear scaling Computable type: DC voltage Scalable range and unit: Same as linear scaling Low-cut: Set the low-cut value in the range of 0.0% to 5.0% of the span. Over value detection: Same as linear scaling 1-5V: Computable range: 1 to 5 V Scalable range and unit: Same as linear scaling Low-cut: The low-cut point is fixed to the span lower limit. Over value detection: Same as linear scaling 2. Alarms Number of alarms: Up to 4 alarms (levels) per measurement channel Alarm type: High limit, low limit, difference high limit, difference low limit, high limit on rate-ofchange alarm. low limit on rate-of-change alarm, delay high limit, and delay low limit Alarm delay time:

1 to 3600 s (for each channel)

Rate-of-change calculation interval of rate-of-change alarms: 1 to 32 times the scan interval (common to all channels)

Alarm output: Output to the internal switch Number of internal switches: 30 Internal switch operation: AND/OR operation selectable

Hysteresis:

High and low limit alarm: 0.0 to 5.0% of the span (common to all channels) Difference high and low limit alarms: 0.0 to 5.0% of the span (common to all channels)

Display: Displays the status on the respective operation screen and an alarm icon on the status display section when an alarm occurs. Display operation: Hold or not hold the display until the alarm acknowledge

operation.

Alarm hide function (alarm no logging function): Not display alarms nor record to the alarm summary (for each channel)

Alarm information:

Displays a log of alarm occurrences on the alarm summary.

Display

1. Display

Display^{*}: 5.7-inch TFT color LCD (240 × 320 dots) Brightness:8 levels

Backlight saver function:

- Dim or turn off the LCD backlight if there is no key operation for a specified time.
- A section of the LCD monitor may contain pixels that are always on or off. The brightness of the LCD may also not be uniform due to the characteristics of the LCD. This is not a malfunction.

2. Displayed Information

Display groups:

Assign channels to groups on the trend display, digital display, and bar graph display and display.

Number of groups: 10

Number of channels that can be assigned to each group: Up to six

Display color:

Channel: Select from 24 colors

Background:

White or black (excludes the Overview display. See the item on the Historical trend display for information on that display.)

Trend display:

Waveform line width

Select from 1, 2, and 3 dots

Display method Orthogonal axis display with time axis

(T) and measured value axis (Y)

Layout: Vertical, horizontal, or wide

Trend intervals: 15 s, 30 s, 1 min, 2 min, 5 min, 10 min, 15 min, 20 min, 30 min, 1 h, 2 h, 4 h, or 10 h/div for the FX1002 and FX1004. 30 s, 1 min, 2 min, 5 min, 10 min, 15 min, 20 min, 30 min, 1 h, 2 h, 4 h, or 10 h/div for the FX1006, FX1008, FX1010, and FX1012. Switchable to the secondary trend interval. Display a scale for each channel. Scale Current value bar graph, color scale band, and alarm point marks can be displayed on the scale. Others Grid (divisions: 4 to 12), trip line (line width: 1, 2, or 3 dots), message, zone display, and partial expanded display Digital Display: Displays measured values numerically Update rate 1 s (scan interval if the scan interval is greater than 1 s) Bar graph display: Displays the measured value on a bar graph Direction Vertical or horizontal Base position End or center Update rate 1 s (scan interval if the scan interval is greater than 1 s) Scale Display a scale for each channel Color scale band, and alarm point marks can be displayed on the scale. Historical trend display: Redisplays the display data or event data in the internal memory or external storage medium* On FXs that have a CF card slot (suffix code -4.)/ SD card slot (suffix code -7.) or USB interface (/ USB1 option). **Display formats** All screen or half screen (only when the display data is being redisplayed) Time axis operation The time axis can be reduced or expanded, and data can be displayed continuously. Add message Messages can be added. Background color Select from white, cream, black, or light gray. Overview Display: Displays the measured values of all channels and the alarm statuses. Information display: Alarm summary display Displays a log of up to 1000 alarms. Specify an alarm with the cursor and jump to the corresponding section on the historical trend display. Message summary display Time and content of up to 450 messages (including 50 add messages) Specify a message with the cursor and jump to the corresponding section on the historical trend display. Memory summary display Displays the information of the data in the memory. Specify a file with the cursor and jump to the corresponding section on the historical trend display.

Save the data in the internal memory to the external storage medium using keys. On FXs that have a CF card/SD card slot or USB interface (/USB1 option) Report (/M1, /PM1, and /PWR1 or /PWR5) Displays report data from the internal memory Stacked bar graph (/M1, /PM1, and /PWR1 or / PWR5) Displays the report data of each report group in a stacked bar graph. Display formats: H+D (hourly data is used for the display), Day+Week (daily data is used for the display), D+M (daily data is used for the display) Report groups: Report channels are arranged in groups of six starting with the first report channel (R01). The group arrangements are fixed. Scale/grid: Fixed at four divisions Update interval: 1 s The report data of the channels in the specified group is displayed in a stacked bar graph. However, only channels that have the same unit of measurement as the first channel in the group are displayed. Status Display Relay status display: Displays the ON/ OFF status of the alarm output relay and internal switch. Modbus client status (/C7): Displays the communication status on the Modbus client Modbus master status (/C2, /C3): Displays the communication status on the Modbus master Log display: Displays the login log, error log, communication log (/C2, /C3, and /C7), FTP log (/C7), Web log (/C7), e-mail log (/C7), SNTP log (/C7), and DHCP log (/C7) System information display: Displays the number of measurement and computation channels, options, MAC address, firmware version, and internal memory capacity, the kind of external storage medium. Network information display (/C7): Displays the FX network setup information 3. Other Displayed Information Tag display: Tag Up to 16 characters Message: Write messages to the trend display. Number of messages 100 Maximum number of saved messages 400 Character Up to 32 characters Write method Write a preset message or write an arbitrary message on the spot. Write destination

Select only the displayed group or all groups.

Auto message

Write a message when the FX recovers from a power failure while memory sampling is in progress.

Write a message when the trend interval is switched during memory sampling.

Add message:

Write messages to the past data positions.

Message The same as the "Message" item above Maximum number of saved messages 50 Status display section:

Displays the FX status in the upper part of the display

Displayed contents

Year, month, day, time, displayed group name/display name, user name (when the login function is in use), batch name (when the batch function is in use), internal memory status, external storage medium status (on FXs with a CF card/ SD card slot), alarm status, function usage status (key lock, computation function—/M1, /PM1, /PWR1 or /PWR5), and e-mail (/C7)

Auto switching of displayed groups:

Switches the display group at a given interval. Interval: Select from the available settings

between 5 s and 1 min.

Default display:

Specify the display to be shown automatically when keys are not operated. Time until the display switches: Select from the available settings between 1 min and 1 h.

Display language:

Select from English, Japanese, German, French, Chinese, Italian, Spanish, Portuguese, Russian, and Korean.

Display selection menu customization: Show/hide and change the positions of each item in the display menus and sub

> menus Insert/delete separators.

Function menu customization:

Show/hide and change the display positions of each item.

Data Saving Function

1. Configuration

Internal memory:

Temporarily saves various types of data. Medium Flash memory

External storage medium (on FXs with a CF card slot): Medium CF card (up to 32GB) Format FAT32 or FAT16

External storage medium (on FXs with a SD card slot): Medium SD card (SD/SDHC) (up to 32GB) Format FAT32 or FAT16

2. Data Type

FX data types and file name extensions

Data Type	Extension	Notes
Display data	.DAD	
Event data	.DAE	
Manual sampled data	.DAM	
Screen image data	.PNG	
Setup data	.PDL	
Report data	.DAR	/M1, /PM1, and /PWR1 or /PWR5

3. Display Data and Event Data

Internal memor	ry: capacity 400 MB					
Number of file		00				
	FO (First In First C					
Display data:		Julij				
Target M	easurement/comp	utation channel				
Sampling inte	ervals					
S	ynchronized to the	trend interval.				
	aximum and minin	num value per				
Sa	ampling interval					
File size U	p to 8 MB					
Data format						
Recording R	ecords data at all t	imes.				
Event data:						
Target M	easurement/comp	utation channel.				
Sampling inte	erval					
D	etermined by the s	ample rate.				
12	25 ms, 250 ms, 50	0 ms, (FX1002 and				
FX	X1004 only)					
1	s, 2 s, 5 s, 10 s, 30) s, 1 min, 2 min,				
5	min, or 10 min					
	ne sampling interva an the scan interva	al cannot be shorter				
	ata per sampling ir	itervar				
Data format	p to 8 MB					
	Binary ree: Records data	at all times				
	igger: Starts recor					
		and records for the				
Combinations	pecified interval.					
		at data anly ar				
Display data only, event data only, or display data and event data						
	display data and event data. Sampled Data Size					
		d Event Dete				
• Data SIZE	of Display Data ar	iu Eveni Dala				
Channel	Display Data	Event Data				

Channel	Display Data	Event Data
Measurement channel	4 bytes/channel	2 bytes/channel
Computation channel	8 bytes/channel	4 bytes/channel

Time data common to all channels is added for each sample.

Time data 8 bytes/sample

Data Size per Sample

Display Data (Number of measurement channels×4 bytes) + (number of computation channels×8 bytes) + 8 bytes (time data) Event Data (Number of measurement channels×2) bytes) + (number of computation channels×4 bytes) + 8 bytes (time data) Sampling Time for a Single File (8 MB) The sampling time for a single file (8 MB) is calculated as follows: Number of samples × sampling interval. The number of samples is calculated as follows: 8 MB/(the data size per sample) Only Display Data If the display data from the 12 measurement channels and the 24 computation channels is recorded at the trend interval of 30 min/div and the display data's sampling interval is 60 seconds: Number of samples = 8 MB/(8 bytes + 12 × 4 bytes + 24 × 8 bytes) = Approximately 32,258 samples Sampling time per file (8 MB) = 32,258 × 60 seconds = 1,935,480 seconds = Approximately 22 days Only Event Data If the event data from the 12 measurement channels and the 24 computation channels is recorded at the sampling interval of 1 second: Number of samples = 8 MB/(8 bytes + 12 × 2 bytes + 24 × 4 bytes) = Approximately 62,500 samples Sampling time per file (8 MB) = 62,500 × 1 seconds = 62,500 seconds = Approximately 17 hours Display data and event data Display data file size = 8 MB Event data file size = 8 MB You can use these figures to calculate the sampling time per file in the same manner as was used for the case of "Only Display Data" or "Only Event Data." You can save multiple files such as those described above to the internal memory or to an external memory device (the number of files that can be stored is limited by the size of the internal memory or external memory device). Calculation Examples of the Sampling Time for a Single File (8 MB) Examples of the sampling time for a single file (8 MB) are shown below. You cannot actually set recording conditions so that the sampling time exceeds 31 days. If the sampling time exceeds 31 days, the file will be divided even if it is not 8 MB in size. 4 Measurement Channels and No Computation Channels

Display data file

Trend interval (time/div)	15 s	30 s	1 min	2 min	5 min	10 min
Sampling interval	0.5 s	1 s	2 s	4 s	10 s	20 s
Sampling time (approx.)	42.7 hours	3 days	7 days	14 days	35 days (-> 31 days)	71 days (-> 31 days)

Event data file

Sampling interval	125 ms	0.5 s	1s	2 s	5s	10 s
Sampling time (approx.)	15.4 days	2 days	5 days	10 days	25 days	51 days (-> 31 days)

12 Measurement Channels and 24 Computation Channels Display data file

Trend interval (time/div)	30 s	1 min	5 min	10 min	30 min	1 hour
Sampling interval	1 s	2 s	10 s	20 s	1 min	2 min
Sampling time (approx.)	9 hours	17.9 hours	3 days	7 days	22 days	44 days (-> 31 days)

Event data file

Sampling interval	1 s	2 s	5 s	10 s	30 s	1 min
Sampling time (approx.)	17.3 hours	1.4 days	3.6 days	7.2 days	21 days	43 days (-> 31 days)

4. Manual Sampled Data

Measured value at an arbitrary time Item: Maximum number of data values that the internal memory can store: 400 Data format: Text

5. Report Data (/M1, /PM1, and /PWR1 or / PWR5)

Item: Report at each scheduled time of report Maximum number of reports that the internal memory can store: 100 Data format: Text

6. Snapshot Data

Item: Displayed screen image data Data format: PNG Output destination: CF card/SD card or communication output

7. Saving Data to the External Storage Medium (On FXs with a CF card/SD card slot or the /USB1 option)

Data Saving:

Saves the data in the internal memory to the external storage medium.

Manual save

Saves when the external storage medium is inserted with a key operation. Auto save*

Display data: Every file save interval Event data: Every data length Manual sampled data:

When manual sampling is executed. Report data: When report is created. Snapshot data: When a snapshot is taken

Auto save operation*

Select "save data only if there is sufficient free space on the CF card/ SD card" or "constantly retain the most recent data files in the CF card/SD card (media FIFO)."

* This is only valid on FXs that have a CF card/SD card slot.

File name Select from "sequence number+userassigned string+date," "sequence number+user-assigned string," or "sequence number+batch name."

Save destination

- Auto save: CF card (only valid on FXs that have a CF card slot (suffix code -4))/SD card slot (only valid on FXs that have a SD card slot (suffix code -7)).
- Manual save: CF card (only valid on FXs that have a CF card slot (suffix code -4)/SD card slot (only valid on FXs that have a SD card slot suffix code -7) or USB flash memory (/USB1 option)

Directory name: Specify using up to 20 characters.

8. Setup Data (On FXs with a CF card/SD card slot or the /USB1 option)

Item: FX setup data Data format: Binary File name: Specify using up to 32 characters. Output/read destination (for saving/loading): CF card/SD card or USB flash memory (/ USB1)

9. Data File Loading (On FXs with a CF card/ SD card slot or the /USB1 option)

Function: Load and show the display data or event data in a CF card/SD card or USB flash memory (/USB1).

10. Miscellaneous

Header comment:

Add up to 50 characters of comment to display data, event data, manual sampled data, or report data file.

Other Standard Functions

1. Event Action Function

Event action:

Execute a specified operation when a given event occurs.

Number of settings: 40

Events: Remote control input, etc.

Timer Number of timers: 4

- Match time timer Number of timers: 4
- Action: Specify memory start/stop, alarm ACK, etc.

There are limitations on the combinations of events and actions.

2. Security Function

Key lock function:

Limitations to key operation, access to the external storage medium (on FXs with a CF card/SD card slot or the /USB1 option), and various operations

Login function:

Only registered users can operate the FX. System administrators

5 administrators (with total operation access)

Users 30 users (with access to operations based on their user access rights)

User access rights setting Limitations to key operation, access to the external storage medium (on FXs with a CF card/SD card slot or the / USB1 option), and various operations

Automatic logout function Users are logged out automatically if there are no key operations for the specified period of time.

3. Time Related Functions

Clock: With a calendar function

- Accuracy ±50 ppm (0 to 50°C); does not include the delay (1 second or less) that occurs when the power is turned on
- Time setting: Set by way of key operations, communication commands (/C2, /C3, and /C7), the event action function, or the SNTP client function (/C7)

Time adjustment method:

While memory sampling

Corrects the time by 40 ms for each second.

Limit in which the time is gradually adjusted: Select from the available settings between 10 s and 5 min.

If the time is outside the limit, the time is immediately corrected.

Cannot be used after hour 0 on January 1st, 2038.

While memory sampling is stopped Immediately change the time.

DST: The date/time for switching between

standard time and DST can be specified. Time zone: Sets the time difference from GMT.

Date format:

Select YYYY/MM/DD, MM/DD/YYYY, DD/ MM/YYYY, or DD.MM.YYYY.

4. Types of Characters That Can Be Handled

Characters:

Alphabet characters, numbers, and symbols (limitation exists) European special character and Cyrillic can be entered via communication command and DAQSTANDARD software.

5. Miscellaneous

Decimal point type:

Period or comma

6. Batch Function

Function: Data management using batch names. Enter text fields and batch comments in the data file.

Batch name:

Added to the file name of the display data and event data.

- Structure Batch number (up to 32 characters) + lot number (up to 8 digits)
- Text field: Adds text to the display data and event data. There are 8 available text fields. Up to 20 title characters and 30 other characters can be entered per field.

Batch comment:

Adds text to the display data and event data. Up to 3 comments with 50 characters or less.

Options

- 1. Alarm Output Relay (/A1, /A2, /A3, and /A4A)
 - Action: Outputs relay contact signals from the terminals on the rear panel when alarms occur.

Number of outputs:

- 2 (/A1), 4 (/A2), 6 (/A3), and 12 (/A4A) Relay contact rating:
 - 250 VAČ (50/60 Hz)/3 A, 250 VDC/0.1 A (for resistance load)

Output format:

2 (/A1), 4 (/A2), 6 (/A3): NO-C-NC, and 12 (/A4A): NO-C

Relay operation:

Energized/deenergized, AND/OR, hold/ non-hold, and reflash settings are selectable.

2. RS-232 Interface (/C2) and RS-422A/485 Interface (/C3)

Connection:

EIA RS-232(/C2) or EIA RS-422A/485(/C3) Protocol: Dedicated protocol or Modbus protocol Synchronization: Start-stop synchronization Transmission mode (RS-422A/485): Four-wire half-duplex multi-drop connection (1:N (N = 1 to 32))Data rate: 1200, 2400, 4800, 9600, 19200, or 38400 bps Data length: 7 or 8 bits Stop bit: 1 bit Parity: Odd, even, or none Handshaking: Off:Off, XON:XON, XON:RS, and CS:RS Communication distance (RS-422A/485): 1200 m Modbus master: Reading information such as measured data from other instruments and writing information to registers Modbus slave: Reading data from measurement and computation channels (/M1, /PM1, and /PWR1 or /PWR5) Reading and writing communication input data (/M1, /PM1, and /PWR1 or /PWR5) Some control commands such as memory start

3. Ethernet Communication Interface (/C7)

Electrical a	and mechanical specifications:
	Conforms to IEEE 802.3 (Ethernet frames
	conform to the DIX specification).
Medium:	Ethernet (10BASE-T)
Protocol:	Dedicated protocol as well as the TCP, IP, UDP, ICMP, ARP, DHCP, HTTP, FTP,
	SMTP, SNTP, and Modbus protocols
E-mail clie	
	Automatically send e-mail at specified
	times.
FTP client	: Automatically transfer the following types
	of data files to the FTP server:
	Display data, event data, screen image
	(snapshot) data, and report data (/M1, /PM1, and /PWR1 or /PWR5)
FTP Serve	,
	Moving and deleting files on the FX,
	managing directories, and generating file
	lists
Web serve	
	Displaying the FX screen on a Web
SNTP clie	browser
	Setting the FX time to the results of an
	SNTP server query
	Cannot be used after hour 0 on January
	1st, 2036.
	ver: Generating the FX's time.
	be used after hour 0 on January 1st, 2036.
DHCP clie	
	Automatically obtain the network address
	settings from the DHCP server.
Modbus cl	
	Reads data from another device and
Modbus se	writes to the registers.
MOUDUS Se	Reading data from measurement and
	computation channels (/M1, /PM1, and
	/PWR1 or /PWR5)
	Reading and writing communication input
	data (/M1, /PM1, and /PWR1 or /PWR5)
	Some control commands such as memory
Setting/Ma	start. Modbus client access limitations. easurement server:
Setting/ine	Using the dedicated protocol control, and
	configure the FX, and generate data from
	the FX.
Maintenan	nce/test server:
	Outputs connection information and
Inotrument	network information. t information server:
msuumen	Generating the information (such as the
	serial number and model name) of the
	connected FX.

4. FAIL/Status Output Relay (/F1)

FAIL output: Relay contact output on CPU error Relay operation

> Energized during normal operation and de-energized on system error.

Status output:

Output a relay contact signal when a selected condition occurs. A combination of the following conditions

can be selected: Low memory, memory failure, media error, A/D hardware error, burnout detection, communication error (Modbus master or client communication error), memory sampling stop.

Relav operation:

Relay is energized when a condition occurs.

Relay contact rating:

250 VAČ (50/60 Hz)/3 A, 250 VDC/0.1 A (for resistance load)

5. Computation Function (including the report function) (/M1)

Number of computation channels: FX1002 and FX1004: 12 channels (101 to 112) FX1006, FX1008, FX1010, and FX1012: 24 channels (101 to 124) Operation: General arithmetic operations: Four arithmetic operations, square root, absolute, common logarithm, natural logarithm, exponential, and power Relational operations: $\langle , \leq , \rangle, \geq , =$, and \neq AND, OR, NOT, and XOR Logic operations: Statistical operations: TLOG and CLOG Special operations: PRE, HOLD, RESET, and CARRY Conditional operation: [a?b:c] Computation accuracy: Double-precision floating point Data that can be used: Channel data Measurement and computation channels Constants 60 constants Communication input data 24 0/1 (/R1) Remote control input status Counts the number of pulses (/PM1) Pulse input Status input Internal switch, alarm output relay (/A[] and /A4A), flags Rolling average: Performs moving average on the computed results. -9999999 to 99999999 Measurement range: Decimal place: 0 to 4 digits to the right of the decimal point Unit: Up to 6 characters in length Sum scales: Off, /s, /min, /h, /day Alarms: High limit, low limit, delay high limit, and delay low limit Hysteresis: High and low limit alarm: 0.0% to 5.0% of the span.

Display: Same as the measurement channels Data saving: Same as the measurement channels Report function: Number of report channels: 12 or 24 (same as the number of computation

channels) Computation types: Average, maximum, minimum, sum, or

Average, maximum, minimum, sum, or instantaneous value

Report types:

Hourly, daily, hourly + daily, daily + weekly, daily + monthly

6. 3-Wire Isolated RTD Input (/N2)

Input terminal:

All the RTD input terminals (A, B, and b) are isolated on each channel. Applies to the FX1006, FX1008, FX1010, and FX1012

Note: On the FX1002 and FX1004 standard models, the A, B, and b terminals are already isolated on each channel.

7. Extended Input (/N3F)

Measurement/display accuracy: Under standard operating conditions

Inp	ut Type	Measuri	ng Range	Measurement Accuracy	Max. Resolution
Thermocouple	Kp vs Au7Fe	0.0 to 300.0 K	0 to 20 K	Within ±4.5 K	0.1 K
			20 to 300 K	Within ±2.5 K	
	PLATINEL	0.0 to 1400.0°C	±(0.25% of rdg + 2.3	з°С)	0.1°C
	PR40-20	0.0 to 1900.0°C	0 to 450°C	Accuracy not guaranteed	
			450 to 750°C	±(0.9% of rdg + 3.2°C)	
			750 to 1100°C	±(0.9% of rdg + 1.3°C)	
			1100 to 1900°C	±(0.9% of rdg + 0.4°C)	
	NiNiMo	0.0 to 1310.0°C	±(0.25% of rdg + 0.7	°C)	
	W/WRe26	0.0 to 2400.0°C	0 to 400°C	±15.0°C	
			400 to 2400°C	±(0.2% of rdg + 2.0°C)	
	Type N (AWG14)	0.0 to 1300.0°C	±(0.2% of rdg + 1.3°	C)	
	XK GOST	-200.0 to 600.0	–200 to –100°C	±(0.25% of rdg + 1.0°C)	
			-100 to 600°C	±(0.25% of rdg + 0.8°C)	
RTD*1	Ni100 (SAMA)	–200.0 to 250.0°C	±(0.15% of rdg + 0.4	P°C)	
	Ni100 (DIN)	–60.0 to 180.0°C	±(0.15% of rdg + 0.4	ŀ°C)	
	Ni120	-70.0 to 200.0°C	±(0.15% of rdg + 0.4°C) ±(0.15% of rdg + 0.3°C)		
	Pt100 GOST	–200.0 to 600.0°C			
	Cu100 GOST	–200.0 to 200.0°C	±(0.15% of rdg + 0.3		
	Cu50 GOST	–200.0 to 200.0°C	±(0.4% of rdg + 0.5°	°C)]
	Pt200 (WEED)	-100.0 to 450.0°C	±(0.3% of rdg + 0.6°	°C)	

*1: Measuring current i = 1 mA

Input source resistance:

Thermocouple input: $2 k\Omega$ or less

RTD input: 1Ω or less per wire (The resistance of all three wires must be equal).

- Ambient temperature influence (with temperature variation of 10°C):
- TC input $\pm (0.1\% \text{ of } rdg + 0.05\% \text{ of } range)$ or less, excluding the error of reference junction compensation
- RTD input $\pm (0.2\%$ of range + 2 digits) or less Input source resistance:
- TC input With variation of +1 k Ω : ±10 μ V or less
- RTD input With variation of 1 Ω per wire (resistance of all three wires must be equal): ±(0.1% of rdg + 1 digit) or less With maximum difference of 100 m Ω between wires: Approx. 1 °C

8. Remote Control (/R1)

Number of input terminals: 8

- Input type: Isolated from the main circuitry through a photocoupler, built-in isolated power supply for the input terminals, and shared common.
- Input type and signal level:

Voltage-free contact

Contact closed at 200 Ω or less and contact open at 100 k Ω or greater. Open collector ON voltage: 0.5 V or less (sink current

- 30 mA or more), leakage current when
- OFF: 0.25 mA or less

Allowable input voltage: 5 VDC

Signal type: Level or edge (250 ms or more)

Action: Executes a specified action by applying a given signal to the remote signal input terminal. Action assignment: Set using the event action function

9. 24 VDC Transmitter Power Supply (/TPS2 and /TPS4)

Number of loops: 2 (/TPS2) or 4 (/TPS4) Output voltage: 22.8 to 25.2 VDC (under rated load current) Rated output current: 4 to 20 mADC Max. output current: 25 mADC (overcurrent protection operation current: approx. 68 mADC) Allowable conductor resistance: $RL \leq (17.8 - minimum transmitter)$ operation voltage)/0.02 A where 17.8 V is the result obtained by subtracting the maximum drop voltage of 5 V when the load shunt resistance is 250 Ω from the minimum output voltage of 22.8 V Max. length of wiring: 2 km (when using the CEV cable) Insulation resistance: 20 M Ω or more at 500 VDC between output terminal and ground Dielectric strenath: 500 VAC (50/60 Hz, I = 10mA) for one minute between output terminal and ground 500 VAC (50/60 Hz, I = 10mA) for one minute between output terminals

10. USB Interface (/USB1)

USB port: Complies with Rev. 1.1 and host function Number of ports: 1 (front panel) Power supply: 5 V, 500 mA Connectable devices: Only connect the devices listed below to prevent damage to the devices. Keyboard Complies with HID Class Ver. 1.1 104 keyboard/89 keyboard (US) and 109 keyboard/89 keyboard (Japanese) External medium USB flash memory Does not guarantee the operation of all USB flash memories. External medium such as a hard disk, ZIP. MO. and optical discs are not supported. The USB memory with security functions not supported.

11. Pulse Input (/PM1)

Pulse input:

- Number of inputs
 - 3 (8 when using the remote control input terminals)
- Input type Isolated from the main circuitry through a photocoupler and built-in isolated power supply for the input terminals. Shared common for pulse inputs.
- Input type and signal level
- Voltage-free contact
 - Contact closed at 200 Ω or less and contact open at 100 k Ω or greater
- Open collector
 - ON voltage: 0.5 V or less (sink current 30 mA or more), leakage current when OFF: 0.25 mA or less
- Counting Counts the rising edges of pulses. For voltage-free contact input:
 - Contact open to contact close For open collector:
 - Voltage level of the terminal H from high to low
- Allowable input voltage 30 VDC
- Max. sampling pulse period 100 Hz
- Minimum detected pulse width
 - 5 ms or more for both low (closed) and high (open)
- Pulse detection period Approx. 3.9 ms (256 Hz)
- Pulse measuring accuracy ±1 pulse Pulse count interval Scan interval or 1 s
- Miscellaneous
 - Pulse input terminals can be used as remote control input terminals, isolated from remote control input terminals
- Remote control:
- Number of inputs: 5. Same as remote control (/R1) for the other specifications Computation function:
 - Same as the computation function (/M1)

12. Calibration Correction (/CC1)

Calibration correction method: Corrects the measured value of each channel using segment linearizer approximation. Number of segment points: 2 to 16 (including the start and end points)

13. DC/AC 24 V Power Supply (/P1)

Rated supply voltage: 24 VDC and 24 VAC (50/60Hz) Allowable power supply voltage range: 21.6V to 26.4 VDČ/AC Insulation resistance: Between power terminal and earth: 20 MΩor greater at 500 VDC. Withstand voltage: Between power terminal and earth: 500 VAC at 50/60 Hz for one minute Rated power supply frequency (for AC): 50/60 Hz Allowable power supply frequency range (for AC): 50 Hz ±2%, 60 Hz ±2% Power supply fluctuation: With variation within 21.6 to 26.4 VDC/ AC: ±1digit or less Power supply frequency fluctuation (for AC): With variation of ±2 Hz from rated power supply frequency: ±(0.1% of rdg+1digit) or less Rated power consumption: 18 VA (for DC), 30 VA (for AC) Power consumption:

Supply voltage	LCD backlight off	Normal	Maximum
24 VDC	5 VA	7 VA	18 VA
24 VAC (50/60Hz)	8 VA	12 VA	30 VA

14. Log Scale (/LG1)

Function: A logarithmic voltage that has been converted from a physical value is applied to the FX, and then the FX's Log scale (logarithmic scale) is used to display and record the physical value. Input type: Log input: Logarithmic input (LogType1) Log linear input: Input that is linear on a logarithmic scale (LogType2) Pseudo log input: An input that supports pseudo logs. (LogType2) Nonlinear log input: An input that supports nonlinear logs on which calibration correction (/CC1 option) is applied. Calibration correction is performed using voltage values. (LogType1) 20 mV, 60 mV, 200 mV, 2 V, 6 V, 20 V, Range: 50 V, and 1 V Unit symbol: Up to 6 characters in length

Scalable range:

Log input (LogType1)

- 1.00E–15 to 1.00E+15 (15 decades maximum) Lower limit mantissa range: 1.00 to 9.99.
 - Upper limit mantissa range: 1.00 to 9.99.

Scale_L < Scale_U

If the lower limit mantissa is 1.00, the difference between the exponents must be 1 or more. If the lower limit mantissa is a value

other than 1.00, the difference between the exponents must be 2 or more.

Log linear input/Pseudo Log Input (LogType2) Lower limit mantissa range: 1.00 to 9.99. Upper limit mantissa range: N/A (the value is the same as the lower limit mantissa).

If the lower limit mantissa is 1.00, the value must be between 1.00E–15 and 1.00E+15, the difference between the exponents must be 1 or more, and the maximum decades is 15.

If the lower limit mantissa is a value other than 1.00, the value must be between 1.01E–15 and 9.99E+14, the difference between the exponents must be 1 or more and the maximum decades is 14.

Alarm: Kind

- d High limit, low limit, delay high limit, and delay low limit nge 1.00E–16 to 1.00E+16, mantissa: 1.00
- Range

to 9.99 Hysteresis 0% (fixed)

Color scale band range:

1.00E–16 to 1.00E+16, mantissa: 1.00 to 9.99 The display position lower limit must be less than the display position upper limit.

Number of mantissa display digits: 2 or 3

Type of LogType2: Select from Log linear or Pseudo Log.

15. Power Monitor (/PWR1, /PWR5)

Measurement element:

By including power measurement elements in an expression, you can measure a variety of power values. Active power, regenerative electric power, reactive power, apparent power, voltage, current, frequency, power factor (LEAD: –, LAG: +), and electric energy (active energy, regenerative energy, reactive energy—LAG: +, reactive energy—LEAD: —, and apparent energy)

 The LEAD/LAG sign is calculated from the phase difference between P1 (voltage) and I1 (current.)
 Phase and wiring system:

Phase and wiring system:

Single-phase two-wire system, singlephase three-wire system, and three-phase three-wire system

Frequency:45 to 65 Hz Rated input voltage:

Rated Voltage	Voltage Range (Variable)	Allowable Input Voltage	Crest Factor
120 V	120 V	150 V	2
240 V	240 V	300 V	2

Rated input current:

/	Ρ	V١	/Ի	ť	1	

Rated	Current Range	Allowable	Crest
Current	(Fixed)	Input Current	Factor
1A	1 A	1.2 A	2

/PWR5

Rated	Current Range	Allowable	Crest
Current	(Fixed)	Input Current	Factor
5 A	5A	6 A	

Allowable input range:

150 Vrms (when the voltage range is set to 120 V), 300 Vrms (when the voltage range is set to 240 V), and 1.2 A (when using current input)

Rated input power and measuring range: Single-phase two-wire system

/PWR1

Input				Approximate Consumed VA	
(AC)	Rated Power	Range ^{*1}	Voltage	Current	
120 V/1 A	100 W	-120 to 120 W	0.2 VA	0.2 VA	
240 V/1 A	200 W	-240 to 240 W	0.4 VA		

/PWR5

Input			Approximate (Consumed VA
(AC)	Rated Power	Range ^{*1}	Voltage	Current
120 V/5 A	500 W	-600 to 600 W	0.2 VA	0.2 VA
240 V/5 A	1000 W	-1200 to 1200 W	0.4 VA	

Single-phase three-wire system /PWR1

Input		Input Measuring	Approximate	Consumed VA
(AC)	Rated Power	Range	Voltage	Current
200 V/1 A	200 W	-240 to 240 W	0.2 VA/ Phase	0.2 VA/ Phase

/PWR5

Input				Approximate Consumed VA	
(AC)	Rated Power	Range	Voltage	Current	
200 V/5 A	1000 W	-1200 to 1200 W	0.2 VA/ Phase	0.2 VA/ Phase	

Three-phase three-wire system /PWR1

Input Measuring Approximate Consumed VA Input (AC) Range **Rated Power** Voltage Current 0.2 VA/ 120 V/1 A 200 W -240 to 240 W 0.2 VA/ Phase Phase 400 W -480 to 480 W 0.4 VA/ 240 V/1 A Phase

/PWR5

Input		Input Measuring	Approximate (Consumed VA
(AC)	Rated Power	Range	Voltage	Current
120 V/5 A	1000 W	-1200 to 1200 W	0.2 VA/ Phase	0.2 VA/ Phase
240 V/5 A	2000 W	-2400 to 2400 W	0.4 VA/ Phase	

The input measuring range when you are using a VT and CT is calculated using the following equation. The measuring range must be within the input measuring ranges listed above, and the primary side input power² must be less than 10 GW.

*1:	Input measuring range (W) = Primary side input
*2:	power in W'²/(VT ratio × CT ratio). Primary side input power = Secondary side rated
۷.	power in W \times 1.2 \times VT ratio \times CT ratio.
Meas	uring range:
	ver factor: (LEAD) 0.5 to 1 to (LAG) 0.5
Free	quency: 45 to 65 Hz
Meas	urement accuracy:
	The performance values listed here were
	recorded under the following standard operating
	conditions: 23 ± 2°C, 55 ± 10%RH; power
	supply frequency: 50/60 Hz ± 1% or less; rated
	input: $\pm 1\%$ or less, power factor: $1 \pm 1\%$ or
	less; warm-up time: 30 minutes or more; and a
	location in which vibration and other factors do
	not affect the operation of the instrument.
Acti	ve power (W): ±1.0% of range (/PWR1)
	±0.5% of range (/PWR5)
Volt	age (V): ±1.0% of range (/PWR1)
0	$\pm 0.5\%$ of range (/PWR5)
Cur	rent (A): ±1.0% of range (/PWR1)
•	±0.5% of range (/PWR5)
Арр	arent power, reactive power, and power factor:
	Value calculated from the measured

values ± 1 digit

Expressions (V and A are rms values)

	Apparent Power (VA)	Reactive Power (Q) (Without using the reactive power measurement method)	Power Factor(PF)
Single-phase two-wire system	$VA = V \times A$	$Q = \sqrt{((VA)^2 - P^2)}$	ΣΡ/ΣVA (Without using the
Single-phase, three-wire system	VAi = Vi × Ai i = 1, 2 ΣVA = VA1 + VA2	Qi = $\sqrt{((VAi)^2 - Pi^2)}$ i = 1, 2 $\Sigma Q = Q1 + Q2$	reactive power measurement method)
Three-phase three-wire system	VAi = Vi × Ai i = 1, 3 ΣVA =√3/2(VA1 + VA3)	Qi = $\sqrt{((VAi)^2 - Pi^2)}$ i= 1, 3 $\Sigma Q = Q1 + Q3$	

The FX's apparent power (VA), reactive power (Q), power factor (PF), and phase (deg) are determined from the voltage(V), current(A), and active power(P) by means of digital computations. Therefore, for distorted signal input, the value obtained on the FX may differ from that obtained on other instruments that use a different method.
 Make sure that the voltage input is at least 10% of the rated value and the current input is at least 5% of the rated value.

Make sure that the voltage input is at least 10% of the rated value and the current input is at least 5% of the rated value.
 In the Σ Q computation, each phase's Q value is computed as negative (–) if the current input is leading the voltage input and as positive (+) if the current input is lagging the voltage input.

Frequency: ±1.0 Hz	Effects of the operating conditions:
 The frequency of the voltage line input to voltage 	Ambient temperature
P1 is output in units of Hz.	±0.05%/°C (under the following
Response time: 2 sec	conditions: 0 to 50°C, 0.05 In \leq I \leq Imax,
Continuous overload:	power factor = 1)
Within the degree of accuracy (rated	±0.07%/°C (under the following
voltage and rated current × 1.2 applied for	conditions: 0 to 50°C, 0.1 In $\leq I \leq Imax$,
2 hours)	power factor = 0.5)
Instantaneous overload:	In: Rated current
Within the degree of accuracy (rated	Voltage variation
voltage × 1.5 applied for 10 seconds,	Within the degree of accuracy (90 to 132
rated current × 2 applied for 10 seconds,	VAC or 180 to 250 VAC; frequency is 50
rated current × 10 applied for 3 seconds)	or 60 Hz)
Dielectric strength:	External magnetic fields
2500 VAC (50/60 Hz) for 1 minute	400 A/m or less
(between the current input, voltage input,	Active power and voltage: ±1.0% of range
and earth)	Effect of the input frequency
Insulation resistance:	For a change within 45 to 65 Hz, the
100 M Ω (500 VDC between the current	effect on the active power, voltage, and
input, voltage input, and earth)	current is within the accuracies.
Computation functions:	
The same as the computation function (
/M1)	

General Specifications

1. Construction

Mounting: Flush panel mounting (on a vertical plane) Mounting angle:

Inclined backward up to 30 degrees from a horizontal plane.

Allowable panel thickness: 2 to 26 mm

 Material
 Case: Metal plate

 Bezel and display cover: Polycarbonate

 Color
 Case: Grayish blue green (Munsell

 2.0B5.0/1.7 or equivalent)

 Bezel: Charcoal gray light (Munsell

 10B3.6/0.3 or equivalent)

 Front panel:

Water and dust proof: Complies with IEC529-IP65, except side-by-side mounting

External dimensions: 144 (W) × 144 (H) × 161.7 (D) mm (D: depth from the panel mounting plane) Weight: FX1002, FX1004, FX1006: 1.3 kg, FX1008, FX1010, FX1012: 1.4 kg, not including options

2. Normal Operating Conditions

Supply voltage: 90 to 132, 180 to 250 VAC Power supply frequency: 50 Hz \pm 2%, 60 Hz \pm 2% Ambient temperature: 0 to 50°C Ambient humidity:

20 to 80%RH (However, less than moisture content of 40°C 80%RH at 40°C or more), No condensation

Vibration: 10 to 60 Hz, 0.2 m/s^2

Shock: Not allowed

Magnetic field: 400 A/m or less (DC and 50/60 Hz) Noise:

Normal mode (50/60 Hz)

DC voltageThe peak value including the signal must be less than 1.2 times the measuring range.

Thermocouple

The peak value including the signal must be less than 1.2 times the measuring thermal electromotive force.

RTD 50 mV or less Common mode voltage

30 VACrms, ±60 VDC, or less for all ranges (Maximum common mode noise voltage: 250 VACrms (50 or 60 Hz)) Maximum noise voltage between channels

FX1xxx-x-x-H: 250 VACrms (50 or 60 Hz) or less FX1xxx-x-x-L: 60 VACrms (50 or 60 Hz) or less Mounting position:

Can be inclined up to 30 degrees

backward. Left and right horizontal.

Warm-up time: At least 30 minutes after power on Installation location: Indoors Operating altitude: 2000 m or less

3. Power Supply

Rated supply voltage: 100 to 240 VAC Allowable power supply voltage range: 90 to 264 VAC

Rated power supply frequency: 50 Hz, 60 Hz Power consumption:

Supply voltage	LCD backlight off	Normal	Maximum
100 VAC	10 VA	15 VA	35 VA
240 VAC	15 VA	20 VA	45 VA

Allowable interruption time:

Less than 1 cycle of the power supply frequency

4. Isolation

Insulation resistance:

Between the Ethernet, RS-422A/485, and insulation terminals and earth: 20 M Ω or greater at 500 VDC

Withstand voltage:

Between the power terminal and earth: 2300 VAC at 50/60 Hz for one minute

Between the contact output terminal and earth: 1600 VAC at 50/60 Hz for one minute Between the measurement input terminal and earth:

1500 VAC at 50/60 Hz for one minute Between the measurement input terminals (excluding the RTD input terminal of the

FX1006, FX1008, FX1010, FX1012):

FX1xxx-x-x-H: 1000 VAC (50 or 60 Hz) for 1 minute

FX1xxx-x-x-L: 400 VAC (50 or 60 Hz) for 1 minute Between the remote input terminal and earth: 1000 VDC for one minute

Between the pulse input terminal and earth: 1000 VDC for one minute

Between the power monitor input terminals (current input, voltage input, and earth): 2500 VAC (50 or 60 Hz) for 1 minute Ground: Grounding resistance: 100 Ω or less

5. Transport and Storage Conditions

Ambient temperature: –25 to 60°C Ambient humidity: 5 to 95%RH (no condensation) Vibration: 10 to 60 Hz, 4.9 m/s² maximum Shock: 392 m/s² maximum (in packaged condition)

6. Supported Standards

- CSA: CAN/CSA-C22.2 No.61010-1, CAN/ CSA-C22.2 No. 61010-2-030, Overvoltage Category II or I^{*1}, Pollution Degree 2^{*2}, Measurement Category II^{*3}
- UL: UL61010-1, UL61010-2-030 (CSA NRTL/C), Overvoltage Category II or I^{*1} , Pollution Degree 2^{*2}, Measurement Category II^{*3}

CE: EMC directive

EN61326-1 Class A, Table 2 (For use in industrial locations) compliant EN61000-3-2 compliant EN61000-3-3 compliant EN55011 Class A, Group 1 compliant

*1: Overvolatge Category : Describes a number Low voltage directive EN61010-1, EN61010-2-030, Overvoltage Category II or I^{*1} Pollution Degree 2^{*2}, Measurement Category II^{*3} RoHS directive distribution board. "2011/65/EU+(EU)2015/863" (10-Substances) compliant I: Applied to /P1 option (24 VAC/DC) WEEE directive: Compliant *2: EMC Regulatory Arrangement in Australia and New Zealand (RCM) EN55011 Class A, Group 1 compliant

KC marking: KN11, KN61000-6-2 compliant

which defines a transient overvoltage condition. limplies the regulation for impulse withstand voltage. "II" applies to electrical equipment which is supplied from the fixed installation like a II: Applied to standard power supply (100-240 VAC)

Pollution Degree 2: Describes the degree to which a solid, liquid, or gas which deteriorates dielectric strength or surface resistivity is adhering. "2" applies to normal indoor atmosphere. Normally, only non-conductive pollution occurs.

*3: Measurement Category II: Applies to measuring circuits connected to low voltage installation, and electrical instruments supplied with power from fixed equipment such as electric switchboards.

7. Standard Performance

Measurement/display accuracy:

Standard operating conditions:

Temperature: 23 ± 2°C

Humidity: 55% ± 10%RH Power supply voltage: 90 to 132 or 180 to 250 VAC

Power supply frequency: 50/60 Hz ± 1% Warm-up time: At least 30 minutes.

Other ambient conditions such as vibration should not adversely affect the operation.

Input Type	Range	Measurement Accuracy (Digital display)	Digital Display Max. Resolution		
DC voltage	20 mV	±(0.05% of rdg + 12 digits)	1 μV		
60 mV 200 mV		±(0.05% of rdg + 3 digits)	10 µV		
			10 µV		
	1 V		100 µV		
	2 V	±(0.05% of rdg + 12 digits)	100 µV		
	1 to 5 V	±(0.05% of rdg + 3 digits)	1 mV		
	6 V		1 mV		
	20 V		1 mV		
	50 V		10 mV		
Thermocouple	R	±(0.15% of rdg + 1°C)	0.1°C		
(Not including the accuracy	S	R, S: 0 to 100°C: ±3.7°C, 100 to 300°C: ±1.5°C B: 400 to 600°C: ±2°C; accuracy not guaranteed for temperatures less than 400°C			
of reference	В				
junction compensation; when the burnout detection function is off.)	К	±(0.15% of rdg + 0.7°C) -200 to -100°C: ±(0.15% of rdg + 1°C)			
	E	±(0.15% of rdg + 0.5°C)			
	J	−200 to −100°C: ±(0.15% of rdg + 0.7°C)			
,	Т				
	N	\pm (0.15% of rdg + 0.7°C) -200 to 0°C: \pm (0.35% of rdg + 0.7°C) Accuracy not guaranteed for values less than -200°C.			
	W	±(0.15% of rdg + 1°C)			
	L	±(0.15% of rdg + 0.5°C)			
	U	-200 to -100°C: ±(0.15% of rdg + 0.7°C)			
	WRe	±(0.2% of rdg + 2.5°C) 0 to 200°C: ±4.0°C			
RTD	Pt100	±(0.15% of rdg + 0.3°C)	0.1°C		
	JPt100				
DI	Voltage	Threshold level (Vth=2.4 V) accuracy ± 0.1 V			
	Contact	With parallel capacitance of 0.01 μ F or less, 1 k Ω or less: 1 (ON). 100 k Ω or more: 0 (OFF)			

Measuring accuracy in case of scaling Accuracy during scaling (digits) = measurement accuracy (digits) × multiplier + 2 digits (rounded up) Fractions rounded up where the multiplier = scaling span (digits)/ measuring span (digits). For 1-5 V range (A/D integration time is Example 16.7 ms or more), measurement span of 1.000 to 5.000 V, and scaling span of 0.000 to 2.000 The measuring accuracy for 5 V input is as follows. Measuring accuracy (1-5 Vrange) $=\pm(0.05\% \times 5 V + 3 \text{ digits}) = \pm(0.0025 V$ $[3 \text{ digits}] + 3 \text{ digits}) = \pm 6 \text{ digits}$ Multiplier = {2000 digits (0.000 to 2.000)}/4000 digits (1.000 to 5.000) = 0.5 Thus, accuracy during scaling = $\pm(6 \times$ 0.5 + 2) digits = 5 digits (rounded up) Reference junction compensation accuracy: When measuring temperature greater than or equal to 0 °C and when input terminal temperature is balanced Type R, S, W, and WRe: ±1.0°C Type K, J, E, T, N, L, and U: ±0.5°C. Type B: Internal reference compensation is fixed to 0°C Maximum input voltage: ±60 VDC (continuous) Input resistance: $^{.}$ 1 V range or less and TC: 10 M Ω or more 2 V range or higher: Approx. 1 MΩ Input source resistance: Volt, TC $2 k\Omega$ or less RTD input 10 Ω or less per wire (The resistance of all three wires must be equal). Bias current: 10 nA or less (except when burnout detection function is enabled) Maximum common mode noise voltage: 250 VACrms (50 Hz/60 Hz) Maximum noise voltage between channels: FX1xxx-x-x-H 250VACrms (50/60Hz) FX1xxx-x-x-L 60VACrms (50/60Hz) Interference across channels: 120 dB (when the input source resistance is 500 Ω and the input to other channels is 60 VDC) Common mode rejection ratio: When the A/D integration time is 20 ms 120 dB (50 Hz ± 0.1%, 500 Ω unbalanced, between the minus terminal and ground) When the A/D integration time is 16.7 ms 120 dB (60 Hz ± 0.1%, 500 Ω unbalanced, between the minus terminal and ground) Normal mode rejection ratio: When the A/D integration time is 20 ms 40 dB or more (50 Hz ± 0.1%) When the A/D integration time is 16.7 ms 40 dB or more (60 Hz ± 0.1%)

8. Effects of Operating Conditions Ambient temperature (with temperature variation of 10°C): DC voltage, TC range $\pm (0.1\% \text{ of } rdg + 0.05\% \text{ of } range) \text{ or less}$ Excluding the error of reference junction compensation RTD range ±(0.1% of rdg + 2 digits) or less Power supply fluctuation With variation within 90 to 132 V and 180 to 250 VAC (50/60 Hz): Accuracy specifications are satisfied. With variation of ±2 Hz from rated power frequency (power supply voltage 100 VAC): Accuracy specifications are satisfied. Magnetic field: AC (50/60 Hz) and DC 400 A/m fields: $\pm (0.1\% \text{ of } rdg + 10 \text{ digits}) \text{ or less}$ Input source resistance: DC voltage range With variation of +1 k Ω : 1 V range or less: ±10 µV or less 2 V range or higher: ±0.15% of rdg or less TC range With variation of +1 kΩ: ±10 µV or less RTD range (Pt100) With variation of 10 Ω per wire (resistance of all three wires must be equal): ±(0.1% of rdg + 1 digits) or less With maximum difference of 40 m Ω between wires: Approx. 0.1 °C Effects of vibration: Effects from a sinusoidal vibration along all three axis at a frequency between 10 to 60 Hz and an acceleration of 0.2 m/s²: $\pm (0.1\% \text{ of } rdg + 1 \text{ digit}) \text{ or less}$ 9. Miscellaneous Memory backup: A built-in lithium battery backs up the settings and runs the clock

Battery life: Approximately 10 years (at room temperature) Application Software

1. Operating environment

Operating System (OS):

Windows 7

Home Premium, SP1 (32- or 64-bit

edition) Professional, SP1 (32- or 64-bit edition)

Windows 8/8.1

(32- or 64-bit edition) (Supports the desktop mode)

Pro (32- or 64-bit edition) (Supports the desktop mode)

Windows 10

Home (32- or 64-bit edition) Pro (32- or 64-bit edition)

Yokogawa will also stop supporting OSs that Microsoft Corporation no longer supports.

CPU and Main Memory: When Using Windows 7 or Windows 8/8.1 or Windows 10 32-bit edition: Intel Pentium 4, 3 GHz or faster x64 or x86 processor; 2 GB or more of memory 64-bit edition: Intel x64 processor that is equivalent to Intel Pentium 4, 3 GHz or faster; 2 GB or more of memory Hard Disk: A free space of 100 MB or more (more space may be required, depending on the amount of data stored). **CD-ROM Drive:** To be used for installing the software. A mouse supported by Windows. Mouse: A video card that is recommended for the Monitor:

OS and a display that is supported by the OS, has a resolution of 1024×768 or higher, and that can show 65,536 colors (16-bit, high color) or more. Printer: A printer supported by Windows is required. An appropriate printer driver is also required.

Adobe Reader: Adobe Reader 7 or later

2. Configuration software:

Setting mode:

Configuration of setting mode and basic setting mode

Configuration via communication:

Configuration of setting mode and basic setting mode without communication configuration (ex. IP address)

3. Data viewer software:

Number of display channels:

32 channels per group, 50 groups maximum

Viewer function:

Waveform display, digital display, circular display, list display, report display, etc.

Data conversion:

File conversion to ASCII, Lotus 1-2-3 or MS-Excel format

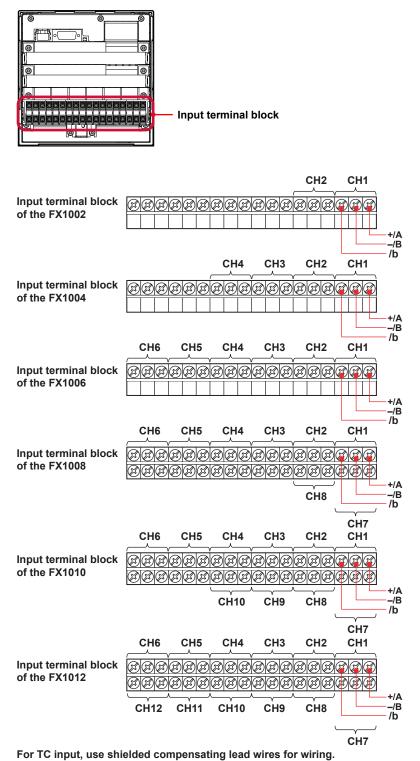
Dimensions

External dimensions

If not specified, the tolerance is ±3%. ſ However, in cases of less than 10mm, the tolerance is ±0.3 mm. If not installing the rubber packing for dust and water protection, *1: 20.2 (0.80), *2: 163.7 (6.44), *3: 110.0 (4.33). Mounting bracket (*2) 161.7 (6.37) ^(*1) 22.2 (0.87) 50) (Dimensions after attaching 161.7 (6.37) 108.0 (4.25) the mounting bracket) anel thickness (*3) 144.0 (5.67) 0 12.6 (2 to 26 (0.08 to 74.5 (2.93) 1.02) **36.5** ± 0.3 (0.01) (2.83) 144.0 (5.67) 161.7 (6.37) 72.0 (2.83) (5.37)72.0 12.6 (0.50) 69.5 (Dimensions after attaching (2.74) the mounting bracket) Panel cut dimensions Single-unit mounting 137 (5.39)^{+ 2}(0.08) 137^{+ 2}0^(0.08) (5.39) ² ^(0.08)in mm (approx. inches) 282 (11.10) Side-by side mounting Units (vertically; max. 3 units) 137 (5.39)⁺ ²₀^(0.08) 2 Side-by-side mounting 426 (16.77) 3 (horizontally) 4 570 (22.44) 5 714 (28.11) 858 (33.78) 6 1002 (39.45) 7 1146 (45.12) 8 **MIN 175** L+ 2 (0.08) (6.89) 137+2 (0.08) 1290 (50.79) 9 10 1434 (56.46) (5.39) (144 × n) – 6 [(5.67 × n) – 0.24] n L⁺²0^(0.08) **MIN 175** (6.89)

Arrangement of the Terminals

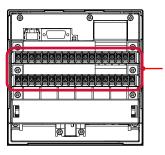
1. Input Terminals



For RTD input, lead wire resistance per wire of 10 Ω or less. Make the resistances of the three wires equal.

For DCA input, example: for 4 to 20 mA input, use a shunt resistor of 250 $\Omega \pm 0.1\%$.

2. Optional Terminals



Optional terminal block

/A1	/A2
Alarm output 02 01	Alarm output 04 03 02 01
/A3	/A4A
Alarm output 04 03 02 01	Alarm output 06 05 04 03 02 01
06 05 Alarm output	12 11 10 09 08 07 Alarm output
/C3	/F1
RS-422A/485	
FG SG SDB SDA RDB RDA	
	FAIL Memory end
/PM1	FAIL Memory
/PM1	FAIL Memory end
/PM1	FAIL Memory end
	FAIL Memory end /R1
	FAIL Memory end /R1
L H L H 5 4 3 2 1 C Pulse input Remote control input	FAIL Memory end /R1 8 7 6 5 4 3 2 1 C Remote control input
L H L H 5 4 3 2 1 C L Pulse input Remote control input /TPS2	FAIL Memory end /R1 B 7 6 5 4 3 2 1 C Remote control input /TPS4 Transmitter power supply output
L H L H 5 4 3 2 1 C Pulse input Remote control input /TPS2 Transmitter power supply output	FAIL Memory end /R1 B 7 6 5 4 3 2 1 C Remote control input /TPS4 Transmitter power supply output
L H L H 5 4 3 2 1 C Pulse input Remote control input /TPS2 Transmitter power supply output	FAIL Memory end /R1 B 7 6 5 4 3 2 1 C Remote control input /TPS4 Transmitter power supply output
L H L H 5 4 3 2 1 C	FAIL Memory end FAIL Memory end /R1 /R1 8 7 6 5 4 3 2 1 C 8 7 6 5 4 3 2 1 C 8 7 6 5 4 3 2 1 C 8 7 6 5 4 3 2 1 C Nemote control input /TPS4 /Transmitter power supply output ////////////////////////////////////
L H L H 5 4 3 2 1 C	FAIL Memory end FAIL Memory end /R1 /R1 8 7 6 5 4 3 2 1 C 8 7 6 5 4 3 2 1 C 8 7 6 5 4 3 2 1 C 8 7 6 5 4 3 2 1 C Nemote control input /TPS4 /Transmitter power supply output ////////////////////////////////////

Model and Suffix Code

Model code	Suffix code		Optional code	Description			
FX1002					2ch, Shortest measurement interval: 125ms		
FX1004					4ch, Shortest measurement interval: 125ms		
FX1006		1	1		6ch, Shortest measurement interval: 1s		
FX1008		1	1		8ch, Shortest measurement interval: 1s		
FX1010					10ch, Shortest measurement interval: 1s		
FX1012					12ch, Shortest measurement interval: 1s		
External storage	-0				Without CF card/SD card slot and medium (Note)		
medium slot	-4				With CF card slot and medium (512MB)		
	-7				With SD card slot and medium (1GB)		
Language		-2			English/Japanese/German/French/Chinese/Italian/Spanish/Portuguese/ Russian/Korean, deg F and DST		
Withstanding volta			-H		1000 VAC(50/60 Hz), 1 min		
measuring input te	erminals	S	-L		400 VAC(50/60 Hz), 1 min		
Options				/A1	Alarm output 2 points (C-contact)*1*10		
				/A2	Alarm output 4 points (C-contact)*1		
				/A3	Alarm output 6 points (C-contact)*1*3		
				/A4A	Alarm output 12 points (A-contact)*1*3		
				/C2	RS-232 interface ²		
				/C3	RS-422A/485 interface ^{*2}		
				/C7	Ethernet interface		
				/F1	FAIL/Status output ^{*3}		
	/M1 Mathem		/M1	Mathematical functions (including Report functions)			
				/N2	3 leg isolated RTD ^{*4}		
				/N3F	Extended input type (without Pt1000)		
				/P1	24 VDC/AC power supply		
				/R1	Remote control 8 points'5		
				/TPS2	24VDC transmitter power supply (2 loops)*6*10		
				/TPS4	24VDC transmitter power suply (4 loops) ⁵⁷		
				/USB1	USB interface (1 port)		
				/PM1	Pulse input 3 points, Remote control 5 points (including Mathematical functions) $^{\mbox{\tiny 8}}$		
				/CC1	Calibration correction function		
				/LG1	Log scale		
				/PWR1	Power monitor (1A) (including Mathmatical functions) ^{19*10*11}		
				/PWR5	Power monitor (5A) (including Mathmatical functions)"9"10"11		

Note: To load data, the FX must be equipped with a communication interface (/C2, /C3, or /C7 option) or the USB interface (/USB1 option). Any combination of /A1, /A2, /A3, and /A4A cannot be specified together.

/C2 and /C3 cannot be specified together.

*1 *2 *3 *4 *5 *6 *7 /A3 or /A4A cannot be specified together. /N2 cannot be specified for FX1002 or FX1004. If /R1 is specified, /A4A, /TPS2, /TPS4, /PM1, or /PWR1 or /PWR5 cannot be specified. If /TPS2 is specified, /TPS4, /A2, /A3, /A4A, /F1, /R1, or /PM1 cannot be specified.

- If /TPS2 is specified, /TPS2, /A3, /A4A, /F1, /R1, or /PM1 cannot be specified. If /TPS4 is specified, /TPS2, /A1, /A2, /A3, /A4A, /F1, /R1, or /PM1 cannot be specified. If /PM1 is specified, /A4A, /M1, /R1, /TPS2, /TPS4, or /PWR1 or /PWR5 cannot be specified. If /PWR1 or /PWR5 is specified, /A3, /A4A, /F1, /R1, /PM1, or /M1 cannot be specified. /TPS2, /PWR1 or /PWR5, and /A1 cannot be specified together. *8
- *9
- *10

*11 /PWR1 and /PWR5 cannot be specified together.

Precaution on purchasing the Log scale (Optional code, /LG1)

To support the nonlinear output of vacuum gauges, the FX must be required with the Log scale (/LG1) and the calibration correction function (/CC1).

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Model code	Description			
FXA120	DAQSTANDARD software			

DAQSTANDARD software (R9.02.01 or earlier) does not support the pseudo log and nonlinear log settings of the FX1000.

Standard Accessories

Name	Model	Qty.	Notes
Mounting brackets	B8730BU	2	For panel mounting
Rubber packing for dust and water protection	-	1	For single-unit mounting
Model FX1002/FX1004/FX1006/FX1008/FX1010/FX1012 FX1000 Paperless Recorder Safety Precautions and Installation Guide Installing FXA120 DAQSTANDARD FX1000 Mode Transition Diagram Setting Mode / Basic Setting Mode Maps	IM 04L21B01-03EN	1	A3 size
CF card ⁻¹	772093	1	512 MB
SD card ⁺²	773001	1	1 GB

On FXs that have a CF card slot (suffix code -4.) *1

CF card capacity is subject to change.

*2 On FXs that have a SD card slot (suffix code -7.)

SD card capacity is subject to change. Download the software (DAQSTANDARD) and electronic manuals from the YOKOGAWA website. *3

Optional Accessories (Sold Separately)

Name	Model	Q'ty	Notes
CF card	772093	1	512 MB
	772094	1	1 GB
	772095	1	2 GB
SD card	773001	1	1 GB
Shunt resistor	X010-250-3	1	$250 \Omega \pm 0.1\%$
	X010-100-3	1	$100 \Omega \pm 0.1\%$
	X010-010-3	1	$10 \Omega \pm 0.1\%$
Mounting brackets	B8730BU	2	-
Terminal screws	B8730CZ	-	M3 (spares for I/O terminals)
	B8730CY	-	M4 (spares for power terminals)

Basic Conditions and Individual Contracts at the Time of Purchase

The warranty for this product is defined in the basic conditions and individual contracts at the time of purchase. The individual conditions are as follows.

Validation

Yokogawa does not guarantee the final outcome of validation work even if there is a defect in the product. For the warranty of validation services, please contact the company that performed the validation work.

Warranty period of firmware The firmware warranty period is one year.

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